

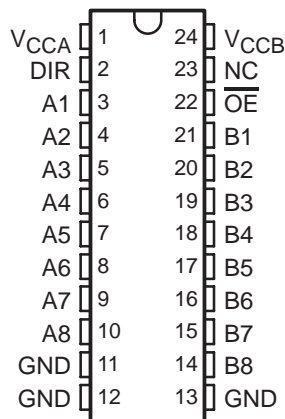
SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

SCAS773A – JUNE 2004 – REVISED MARCH 2005

- **Controlled Baseline**
 - One Assembly/Test Site, One Fabrication Site
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **Bidirectional Voltage Translator**
- **2.3 V to 3.6 V on A Port and 3 V to 5.5 V on B Port**
- **Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DB, DW, OR PW PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

This 8-bit (octal) noninverting bus transceiver contains two separate supply rails. The B port is designed to track V_{CCB} , which accepts voltages from 3 V to 5.5 V, and the A port is designed to track V_{CCA} , which operates at 2.3 V to 3.6 V. This allows for translation from a 3.3-V to a 5-V system environment and vice versa, from a 2.5-V to a 3.3-V system environment and vice versa.

The SN74LVCC3245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are isolated. The control circuitry (DIR, \overline{OE}) is powered by V_{CCA} .

ORDERING INFORMATION

T _A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – DW	Reel of 2000	CLVCC3245AIDWREP	LVCC3245A
	SSOP – DB	Reel of 2000	CLVCC3245AIDBREP	LH245AEP
	TSSOP – PW	Reel of 2000	CLVCC3245AIPWREP	LH245AEP

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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SN74LVCC3245A-EP

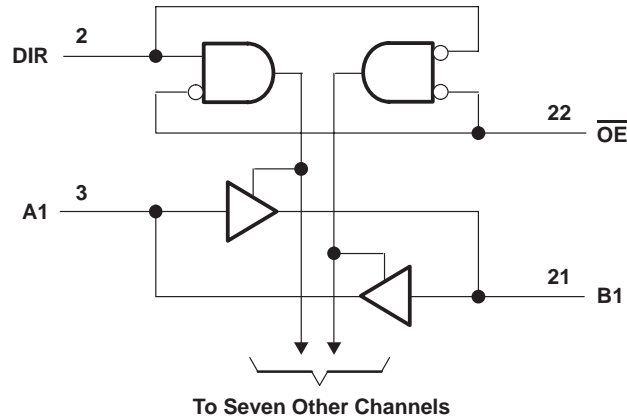
OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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FUNCTION TABLE
(each transceiver)

INPUTS		OPERATION
$\overline{\text{OE}}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CCA} and V_{CCB}	-0.5 V to 6 V
Input voltage range, V_I : All A ports (see Note 1)	-0.5 V to $V_{CCA} + 0.5$ V
All B ports (see Note 2)	-0.5 V to $V_{CCB} + 0.5$ V
Except I/O ports (see Note 1)	-0.5 V to $V_{CCA} + 0.5$ V
Output voltage range, V_O (see Note 2): All A ports	-0.5 V to $V_{CCA} + 0.5$ V
All B ports	-0.5 V to $V_{CCB} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	-50 mA
Output clamp current, I_{OK} ($V_O < 0$)	-50 mA
Continuous output current, I_O	± 50 mA
Continuous current through V_{CCA} , V_{CCB} , or GND	± 100 mA
Package thermal impedance, θ_{JA} (see Note 3): DB package	63°C/W
DW package	46°C/W
PW package	88°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. This value is limited to 4.6 V maximum.
 2. This value is limited to 6 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 4)

		V _{CCA}	V _{CCB}	MIN	NOM	MAX	UNIT
V _{CCA}	Supply voltage			2.3	3.3	3.6	V
V _{CCB}	Supply voltage			3	5	5.5	V
V _{IHA}	High-level input voltage	2.3 V	3 V	1.7			V
		2.7 V	3 V	2			
		3 V	3.6 V	2			
		3.6 V	5.5 V	2			
V _{IHB}	High-level input voltage	2.3 V	3 V	2			V
		2.7 V	3 V	2			
		3 V	3.6 V	2			
		3.6 V	5.5 V	3.85			
V _{ILA}	Low-level input voltage	2.3 V	3 V			0.7	V
		2.7 V	3 V			0.8	
		3 V	3.6 V			0.8	
		3.6 V	5.5 V			0.8	
V _{ILB}	Low-level input voltage	2.3 V	3 V			0.8	V
		2.7 V	3 V			0.8	
		3 V	3.6 V			0.8	
		3.6 V	5.5 V			1.65	
V _{IH}	High-level input voltage (control pins) (Referenced to V _{CCA})	2.3 V	3 V	1.7			V
		2.7 V	3 V	2			
		3 V	3.6 V	2			
		3.6 V	5.5 V	2			
V _{IL}	Low-level input voltage (control pins) (Referenced to V _{CCA})	2.3 V	3 V			0.7	V
		2.7 V	3 V			0.8	
		3 V	3.6 V			0.8	
		3.6 V	5.5 V			0.8	
V _{IA}	Input voltage			0		V _{CCA}	V
V _{IB}	Input voltage			0		V _{CCB}	V
V _{OA}	Output voltage			0		V _{CCA}	V
V _{OB}	Output voltage			0		V _{CCB}	V

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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recommended operating conditions (see Note 4) (continued)

	V _{CCA}	V _{CCB}	MIN	NOM	MAX	UNIT
I _{OHA} High-level output current	2.3 V	3 V			-8	mA
	2.7 V	3 V			-12	
	3.3 V	3 V			-24	
I _{OHB} High-level output current	2.3 V	3.3 V			-12	mA
	2.7 V	3.3 V			-12	
	3.3 V	3 V			-24	
I _{OLA} Low-level output current	2.3 V	3 V			8	mA
	2.7 V	3 V			12	
	3.3 V	3 V			24	
I _{OLB} Low-level output current	2.3 V	3.3 V			12	mA
	2.7 V	3.3 V			12	
	3.3 V	3 V			24	
Δt/Δv Input transition rise or fall rate					10	ns/V
T _A Operating free-air temperature			-40		85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CCA}	V _{CCB}	MIN	TYP	MAX	UNIT
V _{OHA}		I _{OH} = -100 μA	3 V	3 V	2.9	3		V
		I _{OH} = -8 mA	2.3 V	3 V	2			
		I _{OH} = -12 mA	2.7 V	3 V	2.2	2.5		
			3 V	3 V	2.4	2.8		
		I _{OH} = -24 mA	3 V	3 V	2.2	2.6		
2.7 V	4.5 V		2	2.3				
V _{OHB}		I _{OH} = -100 μA	3 V	3 V	2.9	3		V
		I _{OH} = -12 mA	2.3 V	3 V	2.4			
			2.7 V	3 V	2.4	2.8		
		I _{OH} = -24 mA	3 V	3 V	2.2	2.6		
			2.7 V	4.5 V	3.2	4.2		
V _{OLA}		I _{OL} = 100 μA	3 V	3 V			0.1	V
		I _{OL} = 8 mA	2.3 V	3 V			0.6	
		I _{OL} = 12 mA	2.7 V	3 V		0.1	0.5	
			3 V	3 V		0.2	0.5	
		I _{OL} = 24 mA	2.7 V	4.5 V		0.2	0.5	
V _{OLB}		I _{OL} = 100 μA	3 V	3 V			0.1	V
		I _{OL} = 12 mA	2.3 V	3 V			0.4	
			3 V	3 V		0.2	0.5	
		I _{OL} = 24 mA		4.5 V		0.2	0.5	
I _I	Control inputs	V _I = V _{CCA} or GND	3.6 V	3.6 V 5.5 V	±0.1	±1	±1	μA
I _{OZ} [†]	A or B ports	V _O = V _{CCA/B} or GND, V _I = V _{IL} or V _{IH}	3.6 V	3.6 V	±0.5	±5		μA
I _{CCA}	B to A	A port = V _{CCA} or GND, I _O = 0	3.6 V	Open	5	50		μA
		B port = V _{CCB} or GND, I _O = 0	3.6 V	3.6 V	5	50		
			5.5 V	5.5 V	5	50		
I _{CCB}	A to B	A port = V _{CCA} or GND, I _O = 0	3.6 V	3.6 V	5	50		μA
			5.5 V	5.5 V	8	80		
ΔI _{CCA} [‡]	A port	V _I = V _{CCA} - 0.6 V, Other inputs at V _{CCA} or GND, \overline{OE} at GND and DIR at V _{CCA}	3.6 V	3.6 V	0.35	0.5		mA
	\overline{OE}	V _I = V _{CCA} - 0.6 V, Other inputs at V _{CCA} or GND, DIR at V _{CCA}	3.6 V	3.6 V	0.35	0.5		
	DIR	V _I = V _{CCA} - 0.6 V, Other inputs at V _{CCA} or GND, \overline{OE} at GND	3.6 V	3.6 V	0.35	0.5		
ΔI _{CCB} [‡]	B port	V _I = V _{CCB} - 2.1 V, Other inputs at V _{CCB} or GND, \overline{OE} at GND and DIR at GND	3.6 V	5.5 V	1	1.5		mA
C _i	Control inputs	V _I = V _{CCA} or GND	Open	Open	4			pF
C _{io}	A or B ports	V _O = V _{CCA/B} or GND	3.3 V	5 V	18.5			pF

[†] For I/O ports, the parameter I_{OZ} includes the input leakage current.

[‡] This is the increase in supply current for each input that is at one of the specified voltage levels, rather than 0 V or the associated V_{CC}.



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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCA} = 2.5 V ± 0.2 V, V _{CCB} = 3.3 V ± 0.3 V		V _{CCA} = 2.7 V TO 3.6 V, V _{CCB} = 5 V ± 0.5 V		V _{CCA} = 2.7 V TO 3.6 V, V _{CCB} = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _{PHL}	A	B	1	9.4	1	6	1	7.1	ns
t _{PLH}			1	9.1	1	5.3	1	7.2	
t _{PHL}	B	A	1	11.2	1	5.8	1	6.4	ns
t _{PLH}			1	9.9	1	7	1	7.6	
t _{PZL}	$\overline{\text{OE}}$	A	1	14.5	1	9.2	1	9.7	ns
t _{PZH}			1	12.9	1	9.5	1	9.5	
t _{PZL}	$\overline{\text{OE}}$	B	1	13	1	8.1	1	9.2	ns
t _{PZH}			1	12.8	1	8.4	1	9.9	
t _{PLZ}	$\overline{\text{OE}}$	A	1	7.1	1	7	1	6.6	ns
t _{PHZ}			1	6.9	1	7.8	1	6.9	
t _{PLZ}	$\overline{\text{OE}}$	B	1	8.8	1	7.3	1	7.5	ns
t _{PHZ}			1	8.9	1	7	1	7.9	

operating characteristics, V_{CCA} = 3.3 V, V_{CCB} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per transceiver	C _L = 50, f = 10 MHz	38	pF
			4.5	

power-up considerations†

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. To guard against such power-up problems, take these precautions:

1. Connect ground before any supply voltage is applied.
2. Power up the control side of the device (V_{CCA} for all four of these devices).
3. Tie $\overline{\text{OE}}$ to V_{CCA} with a pullup resistor so that it ramps with V_{CCA}.
4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA}. Otherwise, keep DIR low.

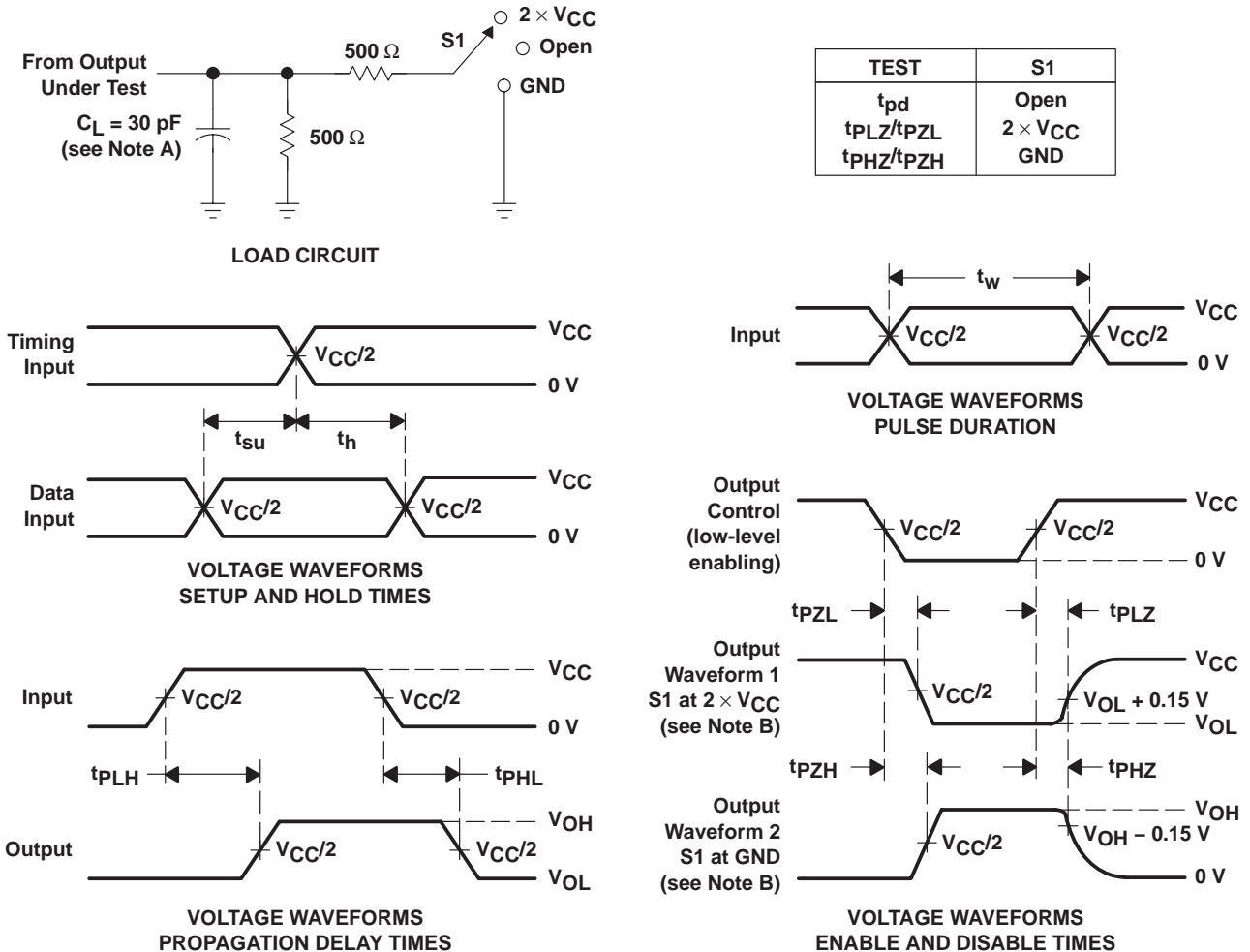
† Refer to the TI application report, *Texas Instruments Voltage-Level-Translation Devices*, literature number SCEA021.



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PARAMETER MEASUREMENT INFORMATION FOR A PORT $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ AND $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2\text{ ns}$, $t_f \leq 2\text{ ns}$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

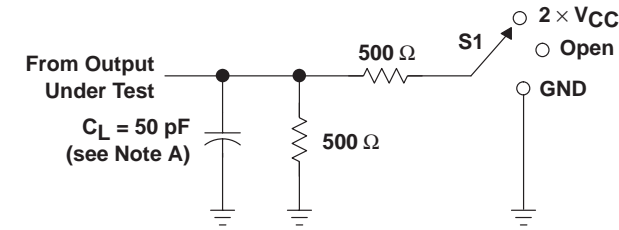
Figure 1. Load Circuit and Voltage Waveforms

SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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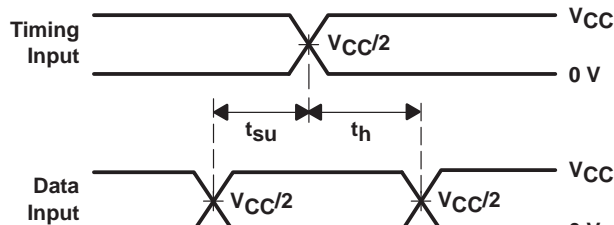
PARAMETER MEASUREMENT INFORMATION FOR B PORT

$$V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V AND } V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$$

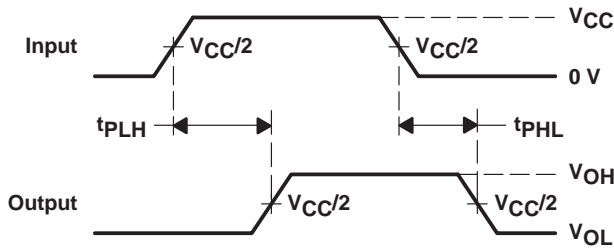


LOAD CIRCUIT

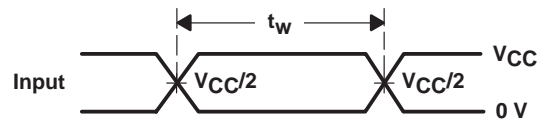
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND



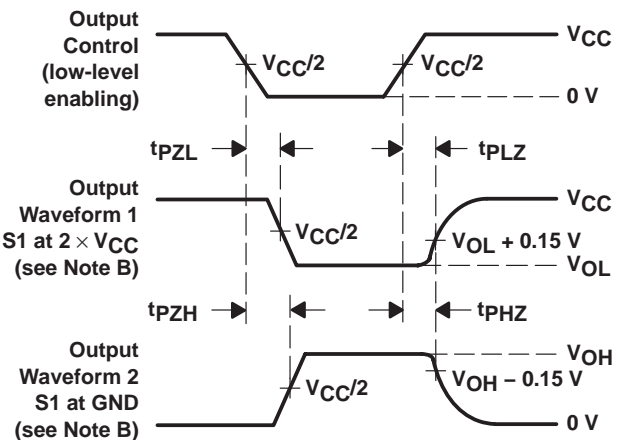
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
 - The outputs are measured one at a time, with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

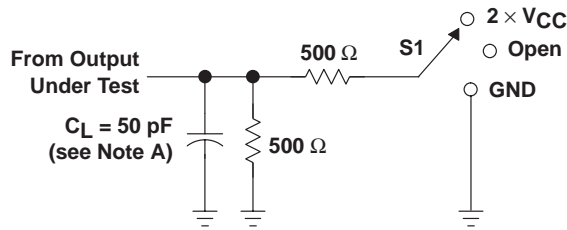
Figure 2. Load Circuit and Voltage Waveforms

SN74LVCC3245A-EP

OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

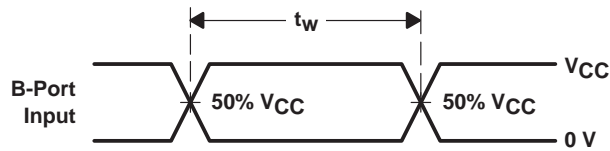
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PARAMETER MEASUREMENT INFORMATION FOR B PORT $V_{CCA} = 3.6\text{ V}$ AND $V_{CCB} = 5.5\text{ V}$

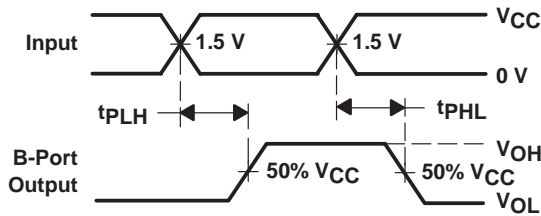


LOAD CIRCUIT

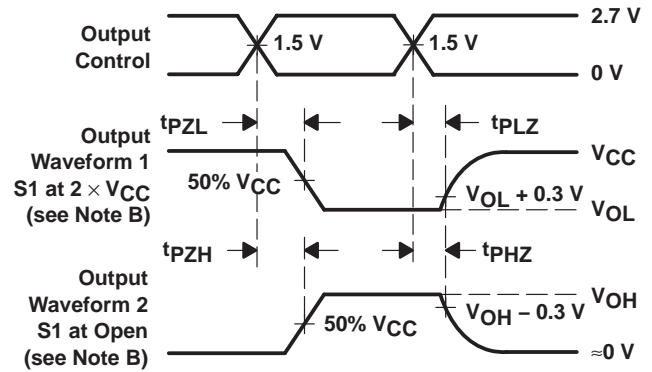
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	Open



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

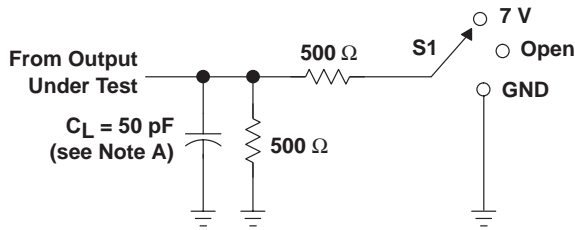
- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 - The outputs are measured one at a time, with one transition per measurement.
 - All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

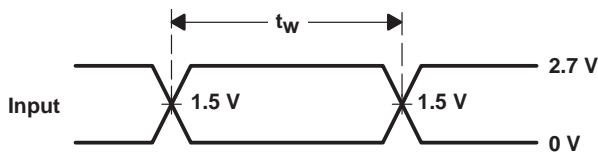
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PARAMETER MEASUREMENT INFORMATION FOR A AND B PORT V_{CCA} AND $V_{CCB} = 3.6\text{ V}$

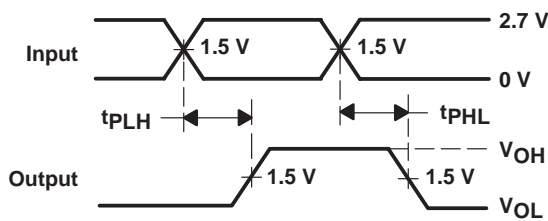


LOAD CIRCUIT

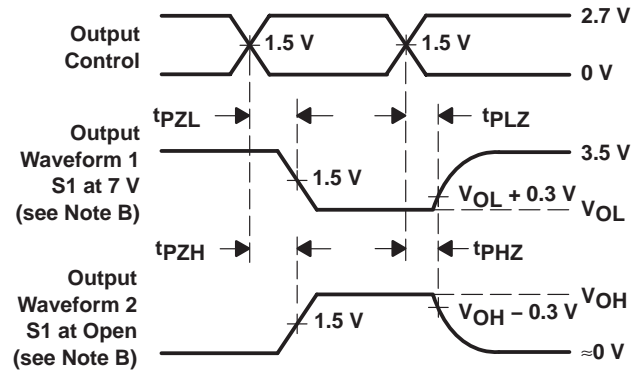
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
CLVCC3245AIDBREP	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
CLVCC3245AIDWREP	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
CLVCC3245AIPWREP	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
V62/05602-01XE	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
V62/05602-01YE	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
V62/05602-01ZE	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74LVCC3245A-EP :

- Catalog: [SN74LVCC3245A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CLVCC3245AIDBREP	SSOP	DB	24	2000	330.0	16.4	8.2	8.8	2.5	12.0	16.0	Q1
CLVCC3245AIDWREP	SOIC	DW	24	2000	330.0	24.4	10.85	15.8	2.7	12.0	24.0	Q1
CLVCC3245AIPWREP	TSSOP	PW	24	2000	330.0	16.4	6.95	8.3	1.6	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

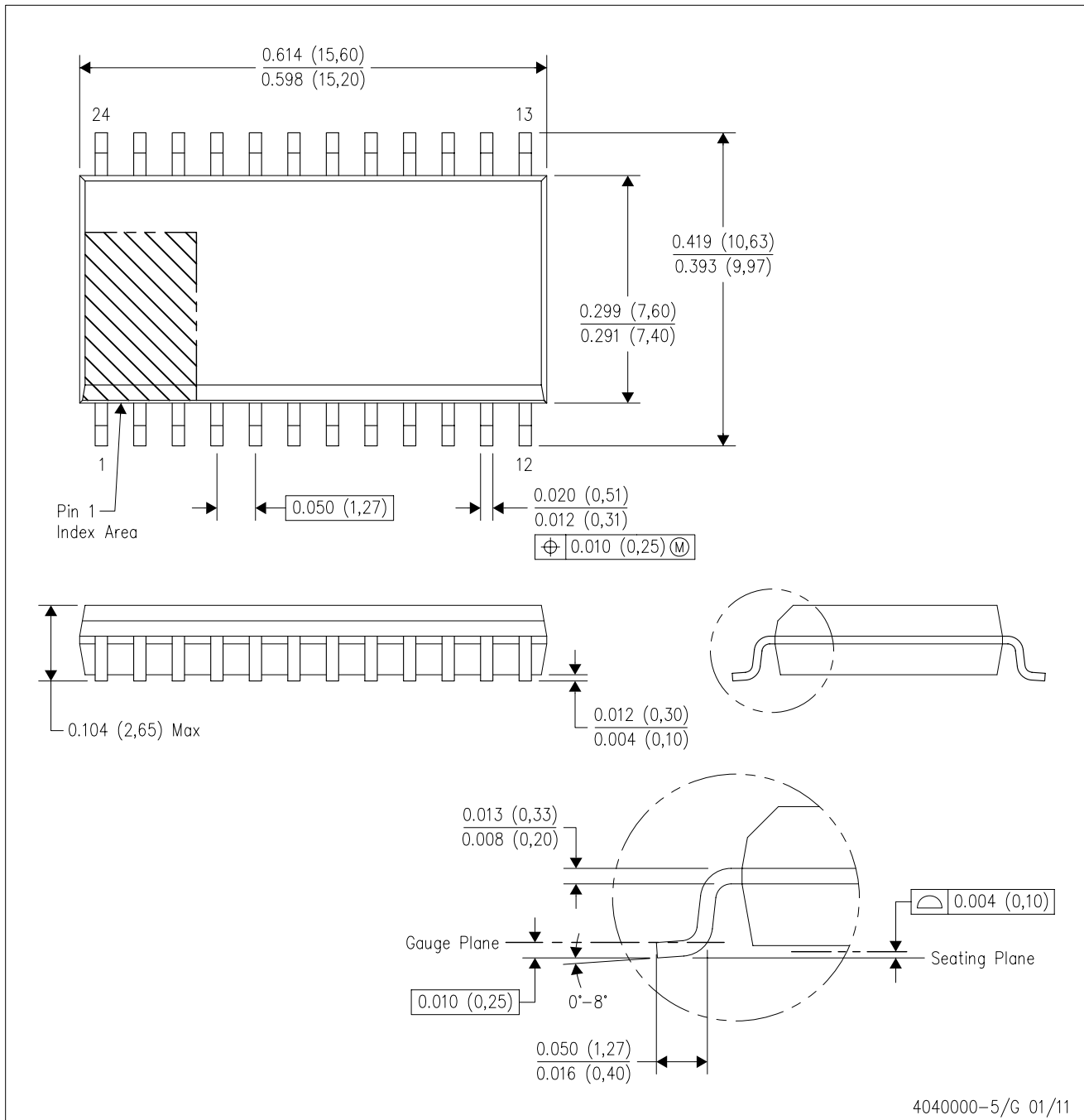


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CLVCC3245AIDBREP	SSOP	DB	24	2000	367.0	367.0	38.0
CLVCC3245AIDWREP	SOIC	DW	24	2000	367.0	367.0	45.0
CLVCC3245AIPWREP	TSSOP	PW	24	2000	367.0	367.0	38.0

DW (R-PDSO-G24)

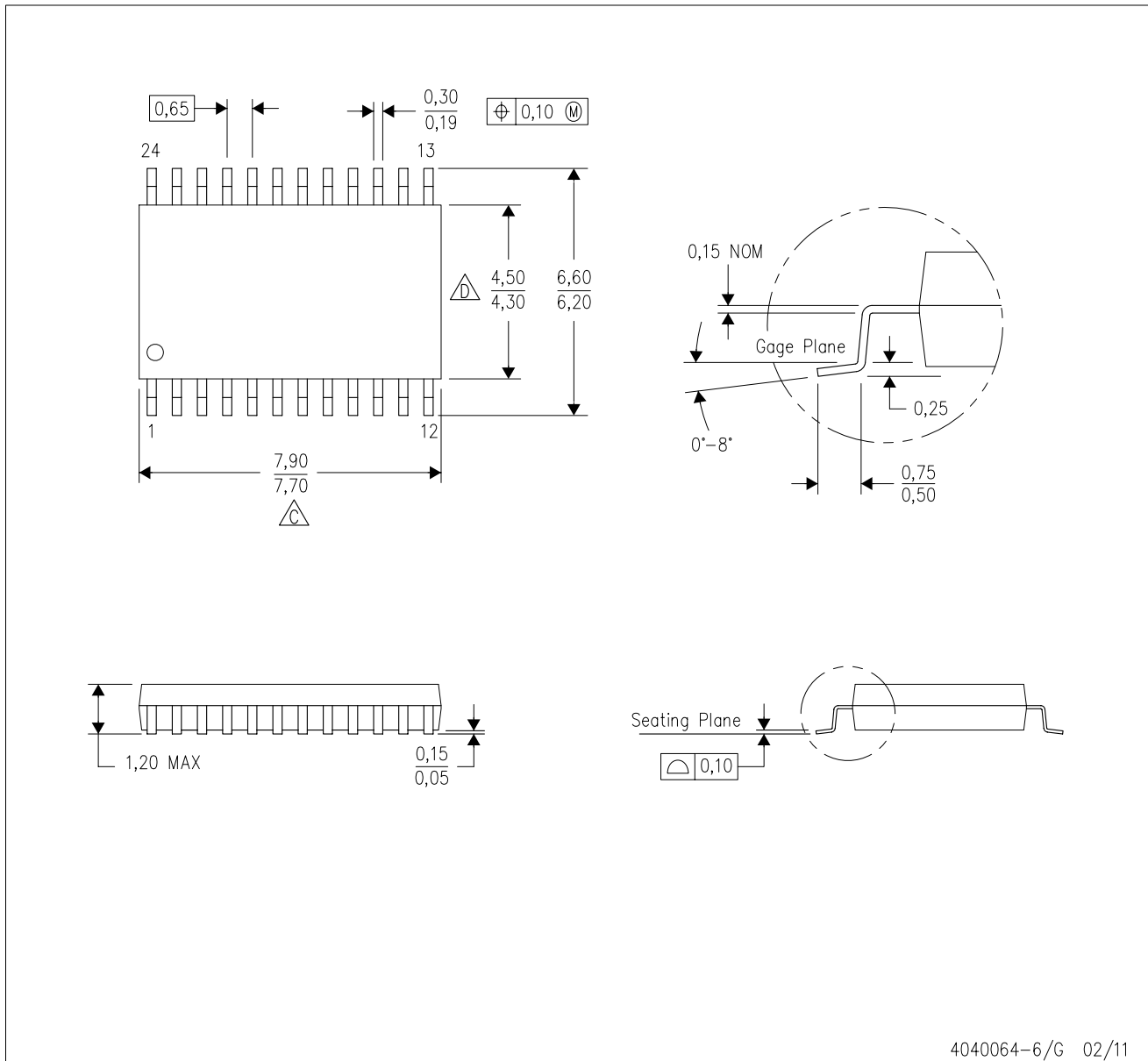
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AD.

PW (R-PDSO-G24)

PLASTIC SMALL OUTLINE

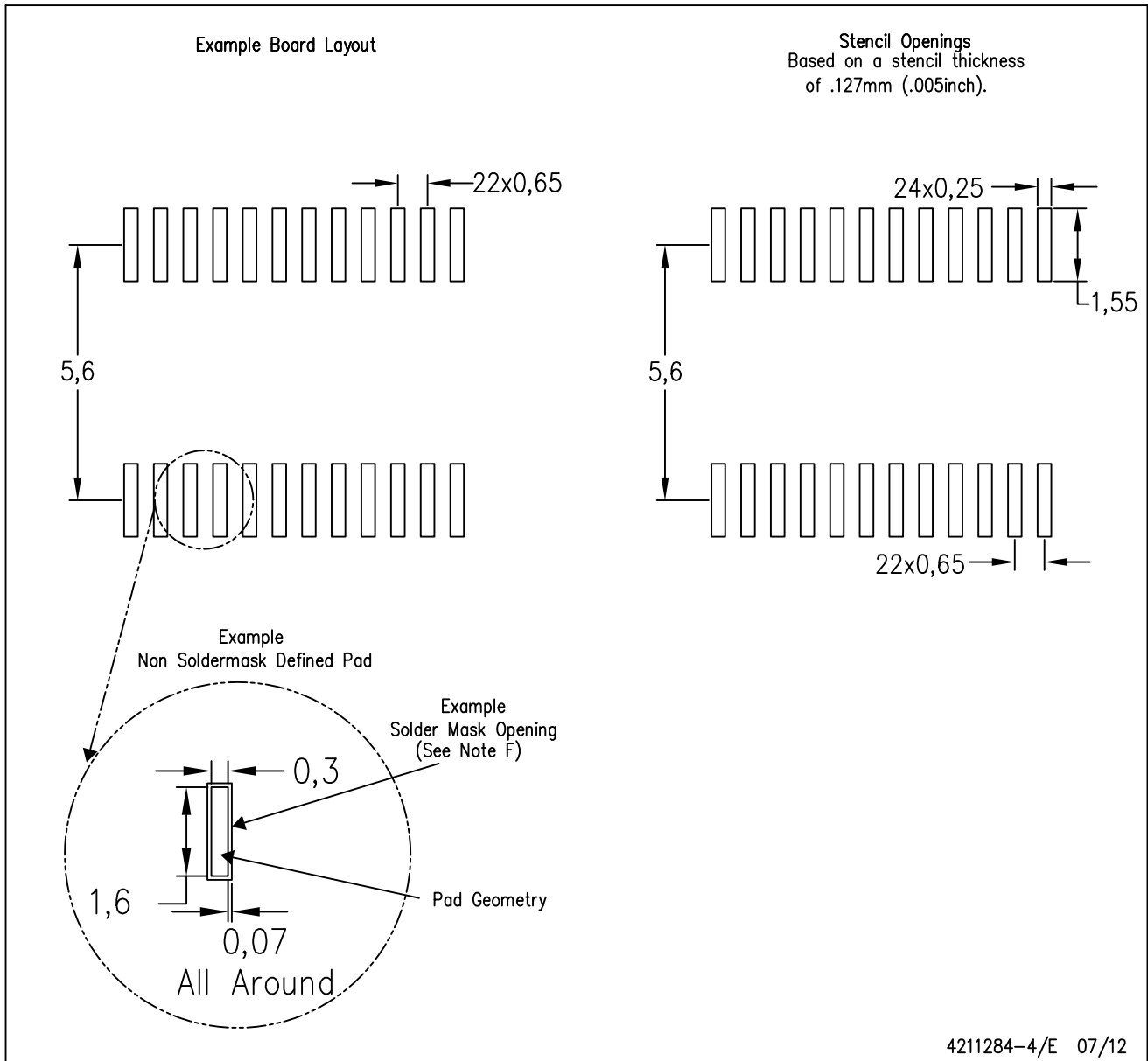


4040064-6/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
 - E. Falls within JEDEC MO-153

PW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate design.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

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